



MICROWAVE CORPORATION v02.0312



HMC272MS8 / 272MS8E

GaAs MMIC SMT SINGLE BALANCED MIXER, 1.7 - 3.0 GHz

Typical Applications

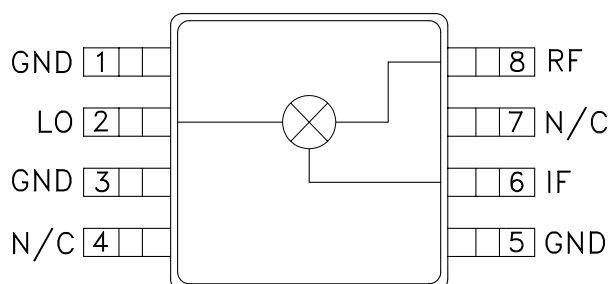
The HMC272MS8 / HMC272MS8E is ideal for:

- Up or Down Converter for PCS
- W-CDMA
- 2.4 GHz ISM
- MMDS

Features

RoHS Compliant Product
Ultra Small Package: MSOP8
LO / RF Isolation: 32 dB
Input IP3: +20 dBm

Functional Diagram



General Description

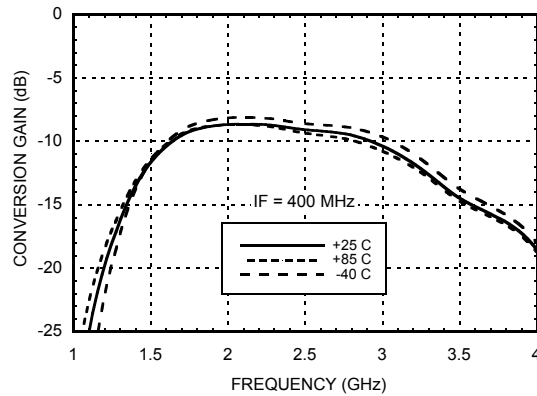
The HMC272MS8 & HMC272MS8E are general purpose ultra miniature single balanced mixers in 8 lead plastic surface mount Mini Small Outline Packages (MSOP). This passive MMIC mixer is constructed of GaAs Schottky diodes and a novel planar transformer balun on the chip. The RF port is balanced via the MMIC balun while the LO port is connected directly to the diodes. The consistent MMIC performance will improve system operation and assure regulatory compliance.

Electrical Specifications, $T_A = +25^\circ \text{C}$, As a Function of IF Frequency

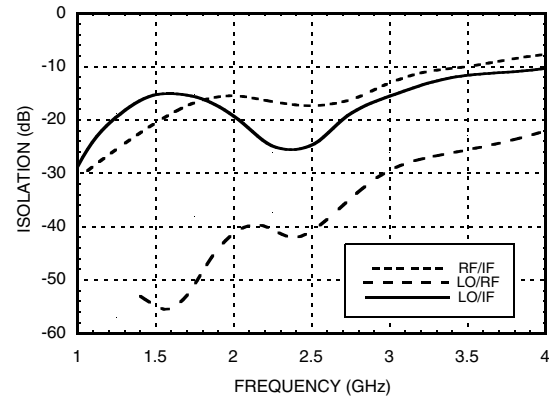
Parameter	LO = +10 dBm IF = 100 MHz			LO = +10 dBm IF = 400 MHz			Units
	Min.	Typ.	Max.	Min.	Typ.	Max.	
Frequency Range, RF & LO	2 - 3			1.7 - 2.8			GHz
Frequency Range, IF	DC - 0.8			DC - 0.8			GHz
Conversion Loss		9	10.5		9	11	dB
Noise Figure (SSB)		9	10.5		9	11	dB
LO to RF Isolation	22	30		24	32		dB
LO to IF Isolation	12	20		11	18		dB
IP3 (Input)	17	21		16	20		dBm
1 dB Compression (Input)	8	11		7	10		dBm

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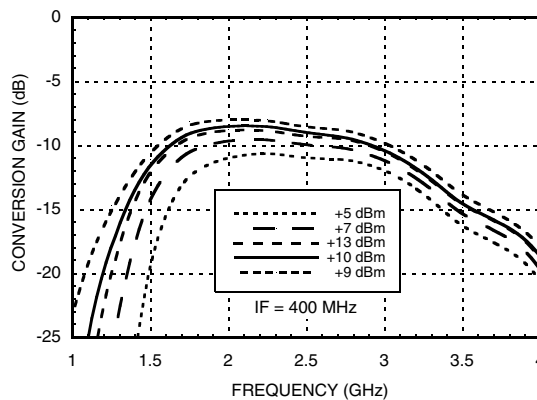
**Conversion Gain vs.
Temperature @ LO = +10 dBm**



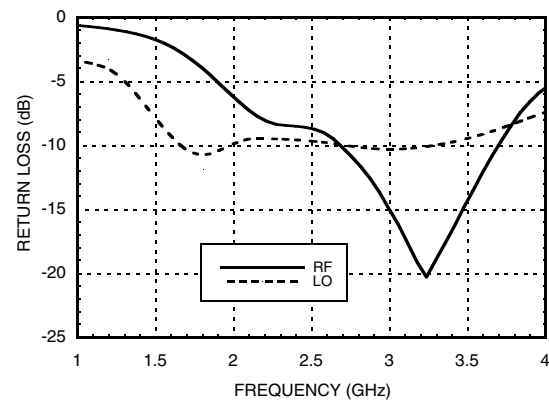
Isolation @ LO = +10 dBm



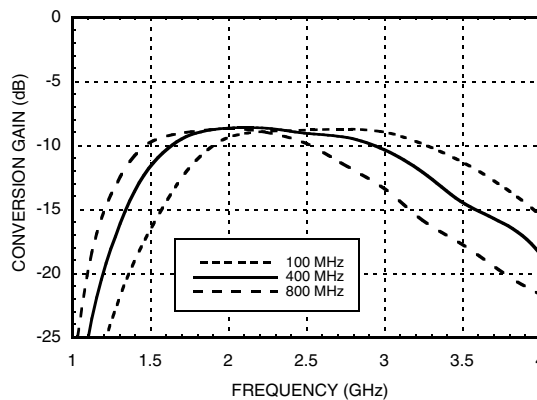
Conversion Gain vs. LO Drive



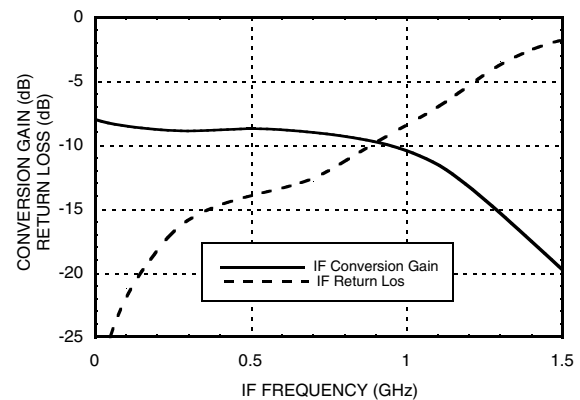
Return Loss @ LO = +10 dBm



Conversion Gain vs. IF Frequency



**IF Bandwidth @ LO = +10 dBm
vs. Conversion Gain & Return Loss**





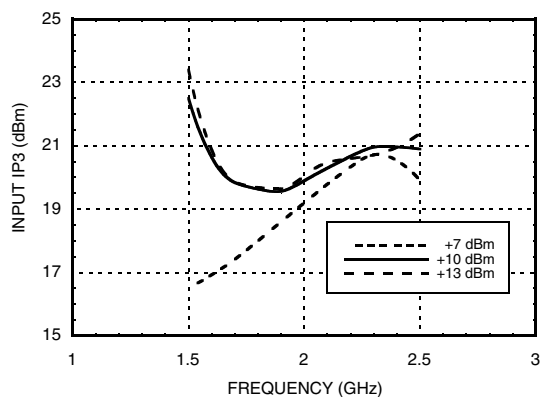
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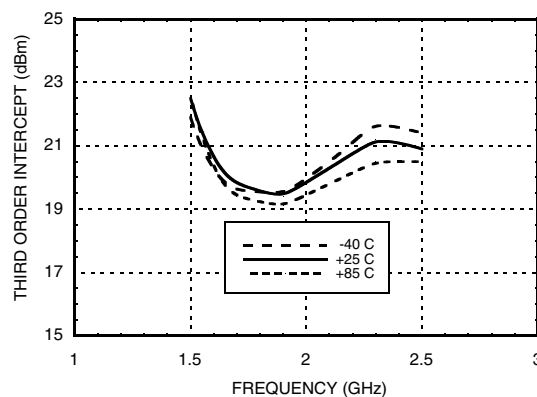
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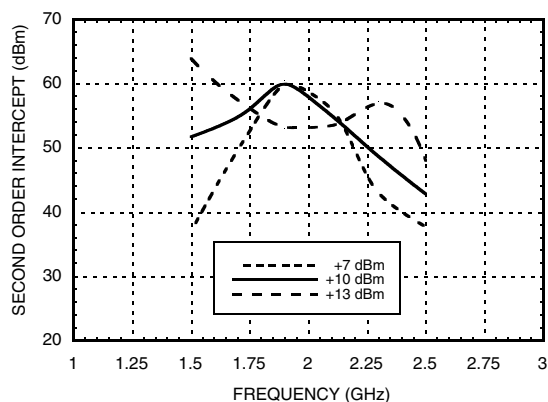
Input IP3 vs. LO Drive



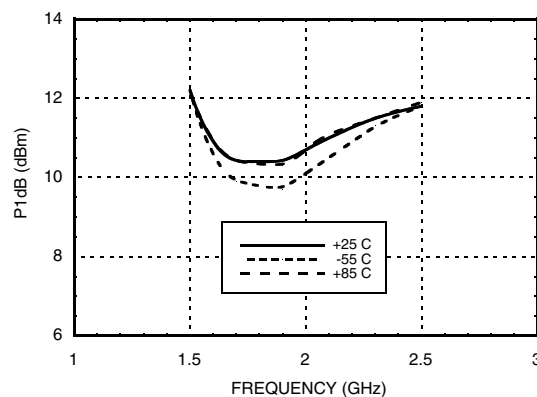
**Input IP3 vs.
Temperature @ LO = +10 dBm**



Input IP2 vs. LO Drive



**P1dB vs.
Temperature @ LO = +10 dBm**



MxN Spurious Outputs

mRF	nLO				
	0	1	2	3	4
0	xx	-8	4	3	27
1	9	0	38	28	43
2	64	58	61	44	67
3	82	89	95	92	87
4	106	>110	>110	>107	>110

RF = 2.6 GHz @ -10 dBm
LO = 2.2 GHz @ +13 dBm
All values in dBc relative to the IF

Harmonics of LO

LO Frequency (GHz)	nLO Spur at RF Port			
	1	2	3	4
1.5	44	19	42	50
1.7	40	16	42	53
1.9	39	18	40	53
2.1	42	20	35	55
2.3	43	23	36	55
2.5	35	26	37	56

LO = +10 dBm
Values in dBc below input LO level measured at the RF port.

Absolute Maximum Ratings

RF / IF Input	+13 dBm
LO Drive	+27 dBm
Channel Temperature	150 °C
Continuous P _{diss} (T= 85 °C) (derate 13 mW/°C above 85 °C)	0.84 W
Thermal Resistance (channel to ground paddle)	77 °C/W
Storage Temperature	-65 to +150 °C
Operating Temperature	-40 to +85 °C
ESD Sensitivity (HBM)	Class 1A



ELECTROSTATIC SENSITIVE DEVICE
OBSERVE HANDLING PRECAUTIONS



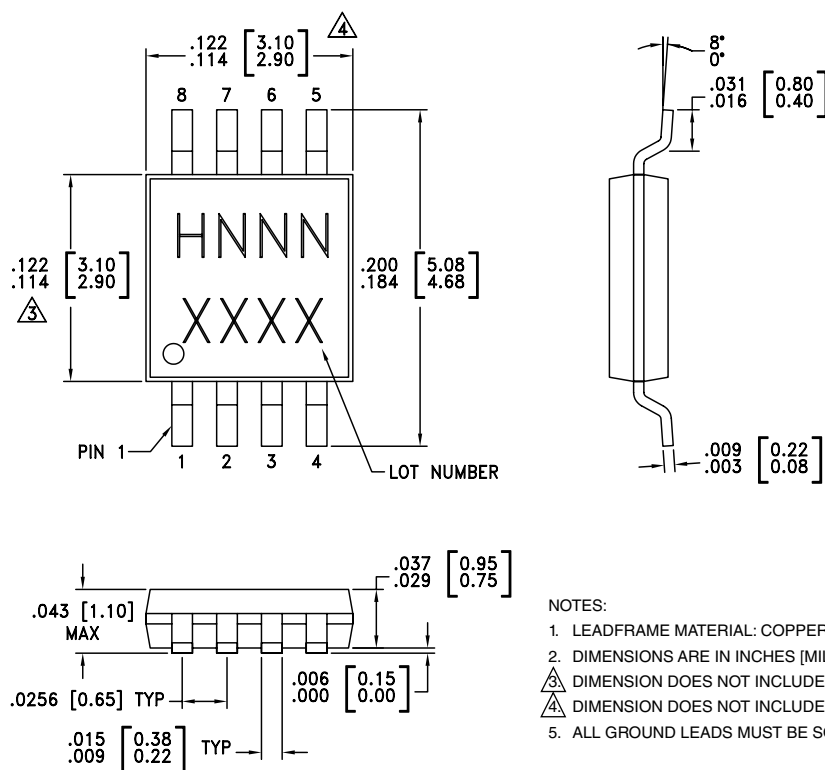
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Outline Drawing



Package Information

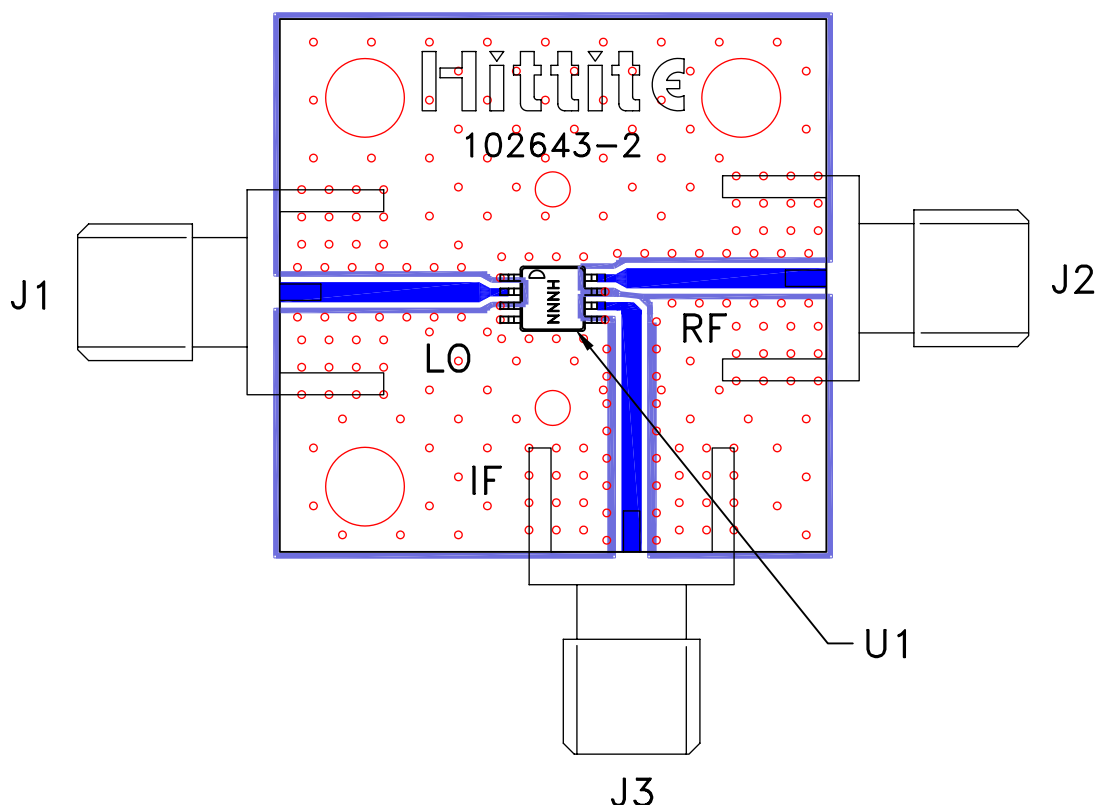
Part Number	Package Body Material	Lead Finish	MSL Rating	Package Marking ^[3]
HMC272MS8	Low Stress Injection Molded Plastic	Sn/Pb Solder	MSL1 ^[1]	H272 XXXX
HMC272MS8E	RoHS-compliant Low Stress Injection Molded Plastic	100% matte Sn	MSL1 ^[2]	H272 XXXX

[1] Max peak reflow temperature of 235 °C

[2] Max peak reflow temperature of 260 °C

[3] 4-Digit lot number XXXX

Evaluation Circuit Board



List of Materials for Evaluation PCB 102781 ^[1]

Item	Description
J1 - J3	PCB Mount SMA RF Connector
U1	HMC272MS8 / HMC272MS8E Mixer
PCB [2]	102643 Evaluation Board

[1] Reference this number when ordering complete evaluation PCB

[2] Circuit Board Material: Rogers 4350

The circuit board used in the application should use RF circuit design techniques. Signal lines should have 50 Ohm impedance while the package ground leads and exposed paddle should be connected directly to the ground plane similar to that shown. A sufficient number of via holes should be used to connect the top and bottom ground planes. The evaluation circuit board shown is available from Hittite upon request.